

[RE-37] TECHNOLOGY OF RADIOELECTRONIC EQUIPMENT MANUFACTURING



Curriculum (Syllabus)

Course details

Level of higher education	First (bachelor's)
Field of knowledge	17 - Electronics, Automation, and Electronic Communications
Specialization	172 - Electronic Communications and Radio Engineering
Educational program	All educational programs
Discipline status	Elective (F-catalog)
Form of higher education	Full-time
Year of training, semester	Available for selection starting from the 3rd year, spring semester
Scope of the discipline	4 credits (Lectures 18 hours, Practical classes 36 hours,
Laboratory work 36 hours, Independent work 66 hours)	
Semester	
Control/control measures	Credit
Class schedule	https://schedule.kpi.ua
Language of instruction	Ukrainian
Information about the course leader/teachers	Lectures: Golovnya V. M. , Labs: Golovnya V. M. , Independent work: Golovnya V. M.

Curriculum

1. Description of the course, its purpose, subject matter, and learning outcomes

Radio-electronic equipment manufacturing technology develops skills in designing technical documentation for products; designing manufacturing processes; developing the necessary equipment; configuration and control; testing finished products at the stages of manufacturing and operation.

If the task of an REA designer is to design a set of technical documentation for a product, then the task of a technologist is to design technological processes and ensure the production of finished products.

Knowledge and understanding of production technology allows for the manufacture of reliable and user-friendly high-tech devices for various purposes and degrees of complexity for various operating conditions.

2. Prerequisites and post-requisites of the discipline (place in the structural-logical scheme of training under the relevant educational program)

Students should be able to work in the SolidWorks environment (discipline "Three-dimensional modeling of REA").

Have an understanding and skills in REA design (discipline "REA Design").

3. Course content

Course content: 18 hours of lectures, 36 hours of lab work, test. Lecture material is additionally covered in lab classes.

Topic 1 Introduction

- Introduction. The place of radio-electronic equipment production technology in the process of designing, manufacturing, and operating radio-electronic equipment.
- Conceptual framework.
- Historical overview.
- Fundamentals of technological preparation for the production of radio-electronic equipment

Topic 2 Subtractive (machining) technologies for manufacturing parts.

- Classification. Mechanisms of influence on materials.
- Mechanical removal of material (cutting, drilling, turning, milling, planing, broaching).
- Chemical, electrochemical, radiation, ion, gas-flame removal of material.
- Physical and chemical processing methods

Additive manufacturing technologies

- Surface preparation
- Physical forming technologies (casting, pressing, powder metallurgy)
- Chemical, electrochemical, radiation, elion, gas-flame technologies
- 3-D technologies for manufacturing products

Topic 4. Technologies for changing properties (processing)

- Physical and chemical processes. Classification.
- Hardening, annealing, normalizing, tempering, work hardening.
- Alloying, diffusion saturation, carbonization, ion implantation

Topic 5 Coatings in the production of radio-electronic devices. Inorganic coatings

- General classification of coatings. Purpose

- Metallization. Technologies for forming other inorganic coatings (oxide, phosphate, nitride, etc.).
- Chemical deposition.
- Electrochemical coatings. Processes. Technology. Polarization
- Corrosion, its types and rate. Passivation. Galvanic corrosion couples. Corrosion protection

Topic 6 Coatings in the production of radio-electronic devices. Organic coatings

- Classification. Definition. Application methods, properties
- Paint and varnish coatings. Application technologies. Areas of application

Topic 7 Fundamentals of IC manufacturing technology

- Photolithography
- Equipment and apparatus Laboratory classes

Main objectives of the laboratory class cycle:

to test acquired theoretical knowledge in practice;

acquiring skills in working with technological equipment;

mastering methods for measuring the parameters and characteristics of products and processes;

acquiring skills in evaluating experimental data and drawing conclusions.

No	Name of laboratory work (computer workshop)	Number lecture hours
1	Research on tools for subtractive material processing. Drills, reamers, broaches	4
2	Research on tools for subtractive material processing. Milling cutters. Grinders. Lathes. Honing machines	4
3	Research on the effect of generation frequency on the productivity of ultrasonic material processing	4
4	Study of the productivity and accuracy of metal processing by electrical erosion method	4
5	Research on precision photomasks	4
6	Research on contact photolithography processes	4
7	Research on cleaning processes and purity control of substrates for ICs	4
8	Research on the principles of constructing vacuum installations for applying thin films	4
9	Credit	4

4. Teaching materials and resources

Laboratory work is carried out in the laboratories of the RTF department of the PRE on the available equipment in labs 306, 410, and 412, and in the microelectronics room, room 408.

Literature for mastering the course

Basic

1. Gotra Z.Y. Electronic Engineering Technology. Textbook in two volumes. Lviv: Lviv Polytechnic Publishing House, 2010. Vol. 1. 888 p.
2. Bilibin K.I. Design and technological engineering of electronic equipment: Kyiv, 2016. 568 p.

3. Technology of non-metallic coating application and production of printed circuit boards [Electronic resource]: textbook / L. A. Yatsyuk, O. V. Kosogin, D. Yu. Ushchapovsky, O. V. Linyucheva, Yu. F. Fateev; Electronic text data (1 file: 6.9 MB). – Kyiv: Igor Sikorsky Kyiv Polytechnic Institute, Polytechnika Publishing House, 2018. – 330 p.

Textbooks.

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8. Zinkovsky, Yuriy Frantsevich. Computer circuit modeling of radio electronics elements: textbook for students of higher educational institutions /Y.F. Zinkovsky, A.V. Koval; Ministry of Education and Science, Youth and Sports of Ukraine, National Transport University. Kyiv: National Transport University, 2013 - Vol. 1, Part 1: Passive element base; Part 2: Filters. --2013. -- 348 p. https://opac.kpi.ua/F/?func=direct&doc_number=000350178&local_base=KPI01
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10. Technology of electronic device manufacturing: Methodological guidelines for laboratory work for students of the Radio Engineering Faculty majoring in "Electronic Devices" /Compiled by V. A. Bidenko, V. A. Kozhushnyi, V. A. Prus; NTUU "KPI". Kyiv: Polytechnika, 2007. – 52 p. https://opac.kpi.ua/F/?func=direct&doc_number=000195324&local_base=KPI01

Monographs.

11. Afanasyeva, Olga Valentinovna. Laser surface treatment of materials: monograph / O. V. Afanasyeva, N. O. Lalarova, E. P. Fedorenko; Ministry of Education and Science of Ukraine, Kharkiv National University of Radio Electronics, Kharkiv National Automobile and Highway University. Kharkiv: Panov A. M., 2020. – 100 p. https://opac.kpi.ua/F/?func=direct&doc_number=000634022&local_base=KPI01
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Teaching aids.

21. Design and production technologies for information recording equipment [Electronic resource]: textbook for students majoring in 171 "Electronics" / Igor Sikorsky KPI; compiled by: V.S. Lazebny, V.V. Pilinsky. - Electronic text data (1 file: 10.2 MB). - Kyiv: Igor Sikorsky Kyiv Polytechnic Institute, 2021. - 450 p. <https://ela.kpi.ua/handle/123456789/41761>
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textbooks.

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33. Burburska S. V., Pasichnyk V. A. Possibilities of additive technologies in the manufacture of high-tech products for mechanical engineering and biomedical engineering //Technical Engineering. - 2022. - No. 1 (89). - P. 21-26.
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Educational content

5. Methodology for mastering the academic discipline (educational component)

To complete each laboratory assignment, knowledge of the lecture material is required. The entire course is divided into 7 topics. Laboratory assignments do not cover all lecture topics, but complement them.

The correspondence between laboratory assignments and lecture material is presented in the table.

Laboratory Lectures	1	2	3	4	5	6	7	8
1	X	X						
2			X					
3				X				
4								
5					X			
6						X		
7								
8								
9							X	X

Topic 1 THE PLACE OF REA PRODUCTION TECHNOLOGY IN THE PROCESS OF DESIGNING, MANUFACTURING, AND OPERATING EQUIPMENT. THE PLACE AND ROLE OF THE TECHNOLOGIST IN THE PRODUCTION OF REA

Topic 1.1 REA technology. The place and role of the technologist in REA production. Basic principles of technological preparation for the production of radio-electronic devices. General issues of technological support for the production process [1, 2, 4, 5, 6, 7].

Topic 1.2 Basic terms and definitions. Regulatory documents on technological preparation of production.

Topic 1.3 Historical overview.

Independent work assignment: principles of organizing the production of radio-electronic equipment parts [1, 2, 4, 5].

Topic 2 SUBTRACTIVE TECHNOLOGIES

Topic 2.1 Classification. Mechanisms of influence on materials. General classification of subtractive methods. Physical and chemical phenomena. Limits of use

Independent work assignment: review the lecture material

Topic 2.2 Mechanical removal of material (drilling, turning). Classification of lathes. Tools. Machining modes. Drilling machines. Types of drills. ZMR.

Independent work assignment: select drills for steel, brass, bronze, wood, polypropylene

Topic 2.3 Mechanical removal of material (cutting, milling, planing). Dragging. Broaching. Classification of milling machines. Tools. Machining modes. Types of milling cutters.

Independent work assignment: select end mills for steel, brass, bronze, wood, fiberglass.

Topic 2.3.1 Chemical and electrochemical material removal. Solid, liquid, and gaseous etchants. Influencing factors. Equipment. Limits of application

Independent work assignment: technological process of etching printed circuit boards, chemical engraving

Topic 2.3.2 Beam, elion, gas-flame removal of material. Jet subtractive technologies. Equipment. Modes. Application

Independent work assignment: design an ion gun (drawing)

Topic 2.4 Physical and chemical methods of material removal. Anodic - mechanical, electroerosion - chemical, ultrasonic - electrochemical and electric laser. Electro-hydraulic pulse and magnetic pulse processing of materials in the production of radio-electronic device components [33]. Yutkin effect.

Independent work assignment: familiarize yourself with the technological capabilities of electroerosion processing [34].

Topic 3. ADDITIVE SHAPING TECHNOLOGIES

Topic 3.1 Surface preparation for coating [2, 25]. Types of ultrasonic cleaning technology for parts, intensification of technological processes [33].

Independent work assignment: develop a cleaning scheme for polycor for vacuum metallization.

Topic 3.2.1 Physical technologies. Metal and plastic casting. Classification. Features. Disadvantages. Advantages. Prospects [13].

Independent work assignment: develop a sketch of a mold [1].

Topic 3.2.2 Physical technologies. Metal and plastic pressing: technological methods [13]. Material requirements. Features of designing pressed products. Features of designing a mold

Independent work assignment: review the lecture material, develop sketches of a simple die and punch [1].

Topic 3.2.3 Physical technologies. Powder metallurgy. Classification. Forming technology. Features of the process. Advantages and disadvantages. Limits of application

Independent work assignment: drawing of powder materials.

Topic 3.3.1 Chemical and electrochemical technologies. Classification. Equipment. Limits of use. Advantages and disadvantages. Prospects for development. Growth modes.

Independent work assignment: review the lecture material.

Topic 3.3.2 Radiation, elion, gas-flame technologies. Classification. Equipment. Limits of use. Advantages and disadvantages, prospects for development. Growth modes.

Independent work assignment: review the lecture material

Topic 3.4 3-D technologies. Classification. Equipment. Limits of use. Advantages and disadvantages, prospects for development. Build-up modes.

Independent work assignment: review the lecture material Topic 4.

TECHNOLOGIES FOR CHANGING PROPERTIES

Topic 4.1 Physical and chemical processes. General classification. Features. Hardware.

Independent work assignment: analyze the limits of use of physical and chemical processes

Topic 4.2 Hardening, annealing, normalizing, tempering, carburizing. Metallization by annealing [2, 14]. Composition of pastes and technological processes of annealing silver and copper

Independent work assignment: familiarize yourself with the technology of preparing pastes for annealing silver [2].

Topic 4.3.1 Alloying, diffusion saturation. Physics of the process. Equipment. Advantages. Disadvantages

Independent work assignment: determine the methods of doping and diffusion saturation for silicon.

Topic 4.3.2 Carbonization, ion implantation. Physics of the processes. Limits of use. Advantages and disadvantages

Independent work assignment: identify methods of carbonization of steel parts

Topic 5 COATINGS IN THE MANUFACTURE OF RADIOELECTRONIC DEVICES. INORGANIC COATINGS

Topic 5.1 General classification of coatings. Purpose. Surface preparation for coating [2, 25].

Independent work assignment: features of surface preparation for coating in the production of printed circuit boards [1].

Topic 5.2.1 Metallization. Classification of metal coatings. Vacuum deposition and spraying. Metallization by annealing [2, 14]. Composition of pastes and technological processes of silver and copper annealing. Hot spraying of metals (shopping, ultra-high-speed spraying). Gas and electric arc devices for shopping.

Independent work assignment: familiarize yourself with the technology of preparing pastes for applying silver [2].

Topic 5.2.2 Technologies for forming other inorganic coatings (oxide, phosphate, nitride, etc.)

Formation methods. Characteristics. Modes. Advantages and disadvantages. Parylene.

Independent work assignment: determine the carbonization method. Art. 3

Topic 5.3 Chemical deposition. Technological and functional coatings obtained by chemical deposition [2, 30]. Typical technological processes and equipment.

Independent work assignment: chemical metallization technology in the production of printed circuit boards [1].

Topic 5.4.1. Electrochemical coatings. Processes. Areas of application and classification of electrochemical coatings. Kinetics of electrochemical processes. Electrolysis. Laws of electrochemical deposition processes. Multilayer electrochemical coatings.

Independent work assignment: features of the design of parts subject to electroplating. [15,17]

Topic 5.4.2. Electrochemical coatings. Polarization and polarization curves. The effect of polarization potentials on the course of electrochemical deposition

Topic 5.5.1 Chemical corrosion, its types and rate. The role of moisture in the corrosion process. Corrosion protection [15].

Independent work assignment: review the lecture material

Topic 5.5.2 Passivation. Galvanic corrosion couples. Protection against electrochemical corrosion. Sacrificial material. Cathodic and anodic protection

Independent work assignment: corrosion couples in electrochemical corrosion [17].

Topic 6 COATINGS IN THE MANUFACTURE OF RADIOELECTRONIC DEVICES. ORGANIC COATINGS

Topic 6.1.1 Definition. Application methods, properties. Factors of environmental impact on radio-electronic equipment. Classification of methods for protecting radio-electronic equipment from external influences with organic layers [1, 2, 29].

Topic 6.1.2 Influence of operating conditions on the choice of coating. Varnishing. Classification of varnishes. Characteristics. Advantages and disadvantages

Independent work assignment: select a varnish for normal operating conditions, for a tropical humid climate, and for a marine climate.

Topic 6.2 Paint coatings, technologies, areas of application. Sealing with polymer materials. The nature of adhesion. Moisture diffusion. Paint and varnish coatings and the physical basis for their application.

Sealing with powder materials. Technologies for sealing parts and assemblies of radio-electronic devices with liquid sealants.

Independent work assignment: impregnation, production technology Topic

7 Fundamentals of IC manufacturing technology

Topic 7.1 Photomasks. Types. Features. Technology of production and application. Resolution.

Topic 7.2 Lithographic processes in IC manufacturing. Photoresists. Types. Application methods. Processing technology. Resolution. Causes of defects and rejects.

6. Independent work

Independent work by students includes mastering lecture and laboratory materials, submitting laboratory work to the instructor for review (within the deadlines specified by the instructor):

7. Policy of the academic discipline (educational component)

- At the beginning of the semester, a Telegram chat is created for the course to facilitate quick communication between students and teachers. All students in the group must be present in the chat.
- Attendance at laboratory work and lectures is mandatory.
- All laboratory assignments must be submitted to the teacher for review by the specified deadlines. Late submission of work results in the loss of the right to redo the work to improve the grade.
- If the teacher has questions about the authorship of the work submitted by the student for review, the teacher has the right to conduct an additional defense of the work.
- Incentive points are awarded for student participation in lectures and laboratory work.
- If they wish, students can prepare reports on a relevant topic of up to 3 pages in A4 format.

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8. Types of control and rating system for assessing learning outcomes

The following maximum points can be obtained for each task (provided that it is completed correctly and submitted for review on time):

1. Lectures - 18 points in total (based on the results of a quick survey)
2. Laboratory work - 10 points for each
3. Report - 5 points for each

Calendar control

Students who have earned 30 and 60 points, respectively, on the date of the first and second calendar controls will receive certification.

Note: Provided that laboratory work is evenly distributed throughout the semester. If the latter condition is not met, students will be notified at the beginning of the semester about the change in the calculation of rating points.

Semester control: credit.

Table of correspondence between rating points and grades on the university scale

Number of points	Grade
100-95	Excellent
94	Very good
84	Good
74-65	Satisfactory
64-60	Sufficient
Less than 60	Unsatisfactory
Admission requirements not met	Not admitted

9. Additional information on the discipline (educational component)

- Certificates of completion of distance or online courses on relevant topics may be accepted (the relevance of the topics must be agreed with the lecturer).

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Description of material, technical, and informational support for the discipline

The laboratory work provided for in the course is equipped with the necessary measuring instruments (caliper, protractor, microscope, etc.), cutting tools, molds, and materials in full. Appropriate models have been developed and manufactured for performing electrical discharge and ultrasonic processing. Work on IC technology is carried out in the microelectronics laboratory on serial cleaning, photolithography, vacuum deposition of materials, and film thickness control equipment.

Additional information is provided on posters and tablets. Students also get to know the existing lathes, milling machines, engraving machines, and drilling machines in the department's workshop.

Work program for the academic discipline (syllabus):

Compiled by [V. M. Golovnya](#);

Approved by the PRE department (protocol No. 6/2024 dated 06/27/2024)

Approved by the methodological commission of the faculty/research institute (protocol No. 6/2024 dated 28.06.2024)